

NCE N-Channel Super Trench Power MOSFET

Description

The NCEP1580F uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{\text{DS(ON)}}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

General Features

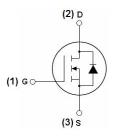
- V_{DS} =150V, I_{D} =42A $R_{DS(ON)}$ <12.5mΩ @ V_{GS} =10V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

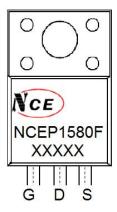
- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

100% UIS TESTED!

100% ΔVds TESTED!



Schematic diagram



Marking and pin assignment



TO-220F top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP1580F	NCEP1580F	TO-220F-3L	-	-	-

Absolute Maximum Ratings (T_c=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	VDS	150	V	
Gate-Source Voltage	Vgs	±20	V	
Drain Current-Continuous	I _D	42	А	
Drain Current-Continuous(Tc=100℃)	I _D (100℃)	29.4	А	
Pulsed Drain Current	I _{DM}	168	А	
Maximum Power Dissipation	P _D	55	W	
Derating factor		0.37	W/°C	
Single pulse avalanche energy (Note 5)	Eas	672	mJ	
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	$^{\circ}$	

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NCEP1580F

Thermal Characteristic

Thermal Resistance,Junction-to-Case ^(Note 2)	R _{θJC}	2.7	°C/W	
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Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	,					•
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	150	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =150V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20 V , V_{DS} =0 V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	2.5	-	4.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =20A	-	10.6	12.5	mΩ
Forward Transconductance	g FS	V _{DS} =10V,I _D =20A	-	38	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}	75,474 074	-	3200	-	pF
Output Capacitance	Coss	$V_{DS}=75V, V_{GS}=0V,$	-	382	-	pF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	17.9	-	pF
Switching Characteristics (Note 4)			'			
Turn-on Delay Time	t _{d(on)}		-	17	-	nS
Turn-on Rise Time	t _r	V_{DD} =75 V , I_{D} =20 A	-	35	-	nS
Turn-Off Delay Time	t _{d(off)}	$V_{GS}\text{=}10V, R_{G}\text{=}4.7\Omega$	-	32	-	nS
Turn-Off Fall Time	t _f		-	9	-	nS
Total Gate Charge	Qg)/ 75 1/1 00 A	-	44.1	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =75 V , I_D =20 A ,	-	14.8	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	10.5	-	nC
Drain-Source Diode Characteristics	1		1	1		1
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =20A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	42	Α
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F = I _S	-	58	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	138	-	nC
				i		

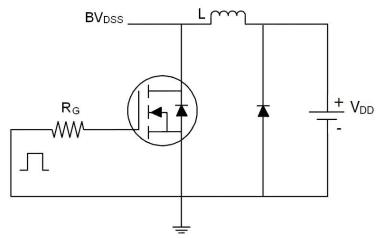
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^{\circ}\text{C}\text{,V}_{DD}\text{=}50\text{V,V}_{G}\text{=}10\text{V,L=}0.5\text{mH,Rg=}25\Omega$

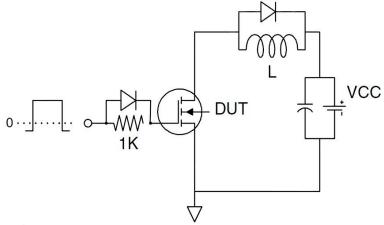


Test Circuit

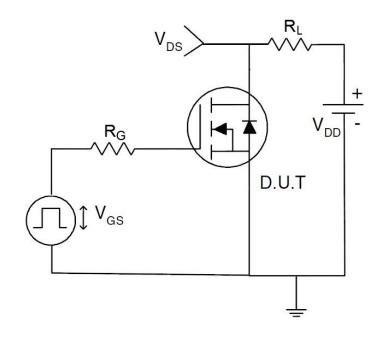
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit







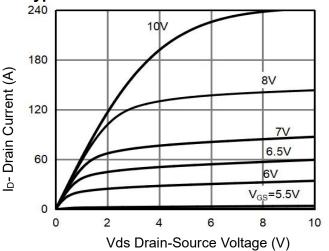


Figure 1 Output Characteristics

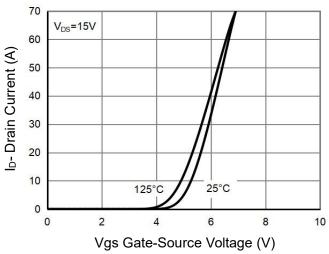


Figure 2 Transfer Characteristics

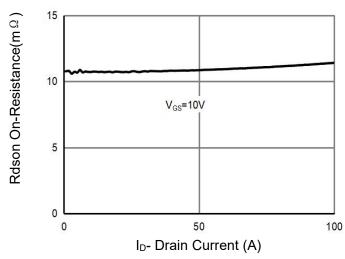


Figure 3 Rdson- Drain Current

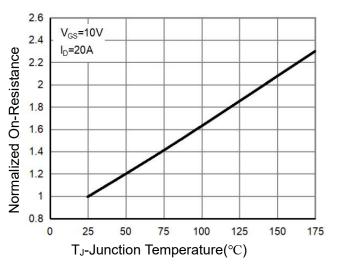


Figure 4 Rdson-JunctionTemperature

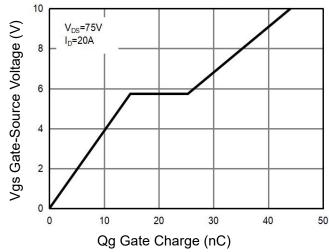


Figure 5 Gate Charge

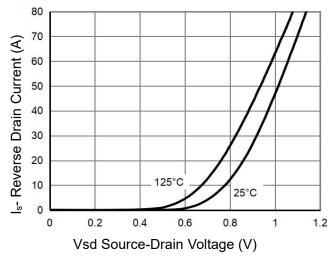


Figure 6 Source- Drain Diode Forward



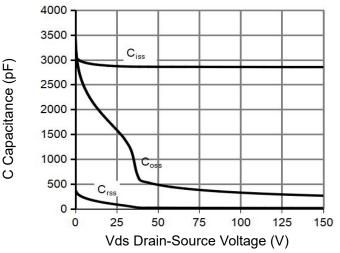


Figure 7 Capacitance vs Vds

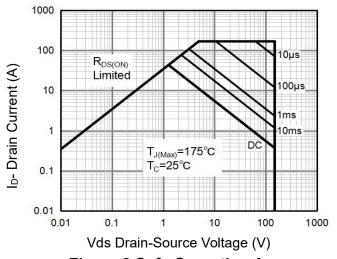


Figure 8 Safe Operation Area

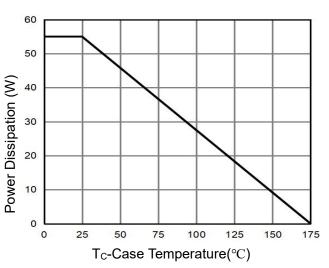


Figure 9 Power De-rating

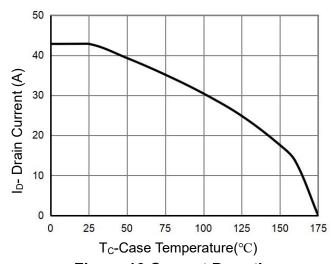
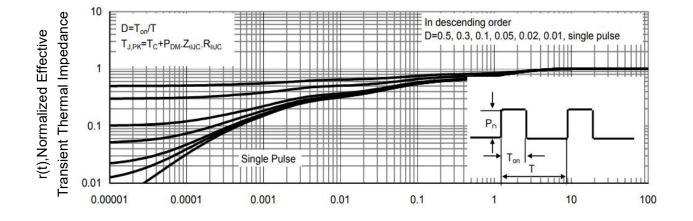


Figure 10 Current De-rating

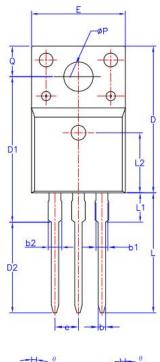


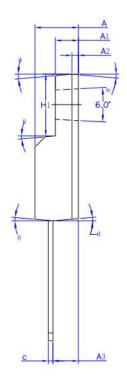
Square Wave Pluse Duration(sec)

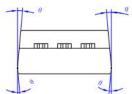
Figure 11 Normalized Maximum Transient Thermal Impedance



TO-220F Package Information







SYMBOL	MIN	NOM	MAX		
Α	4.50	4.70	4.83		
A1	2.34	2.54	2.74		
A2		EF			
A3	2.56	2.56 2.76			
b	0.70	2-3	0.90		
b1	1.18	12 <u>—</u> 3	1.38		
b2	= 1		1.47		
С	0.45	0.50	0.60		
D	15.67	15.87	16.07		
D1	15.55	15.75	15.95		
D2	9.60	9.80	10.0		
E	9.96	10.16	10.36		
е	2				
H1	6.48	6.68	6.88		
L	12.68	12.98	13.28		
L1	-	-	3.50		
L2	(
ØΡ	3.08	3.18	3.28		
Q	3.20		3.40		
θ 1	1°	3°	5°		



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